

Special Issue

Emerging Trends in Artificial Intelligence and Computer Science for E-Learning

Message from the Guest Editors

We are pleased to invite you to contribute to the Special Issue “Emerging Trends in Artificial Intelligence and Computer Science for E-Learning”. This Special Issue explores the role of advanced artificial intelligence and computer science techniques for distance learning, covering a wide range of topics—from autonomous student learning to assessment methodologies. This Special Issue welcomes contributions from diverse academic communities, including education and computer science, engaging all stakeholders involved in these fields.

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Deadline for manuscript submissions

30 June 2026



Applied Sciences

an Open Access Journal
by MDPI

Impact Factor 2.5
CiteScore 5.5



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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